



SNS COLLEGE OF TECHNOLOGY

Coimbatore-35
An Autonomous Institution



Accredited by NBA – AICTE and Accredited by NAAC – UGC with 'A++' Grade (III Cycle)
Approved by AICTE, New Delhi & Affiliated to Anna University, Chennai

DEPARTMENT OF ELECTRONICS & COMMUNICATION ENGINEERING

19ECB302-VLSI DESIGN

III YEAR/ V SEMESTER

UNIT 1 –MOS TRANSISTOR PRINCIPLE

TOPIC 4 –MOS IV CHARACTERISTICS

30 July 2024

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OUTLINE



- INTRODUCTION
- MOS CAPACITOR
- TERMINAL VOLTAGES
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- I-V CHARACTERISTICS
- CARRIER VELOCITY
- ACTIVITY
- NMOS & PMOS I-V PLOTS
- EXAMPLES
- ASSESSMENT
- SUMMARY

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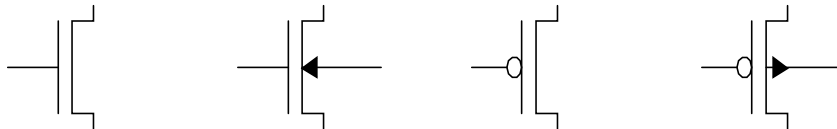
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INTRODUCTION



- An ON transistor passes a finite amount of current
 - Depends on terminal voltages
 - Derive current-voltage (I-V) relationships
- Transistor gate, source, drain all have capacitance
 - $I = C (DV/Dt) \rightarrow Dt = (C/I) DV$
 - Capacitance and current determine speed
- Also explore what a “degraded level” really means



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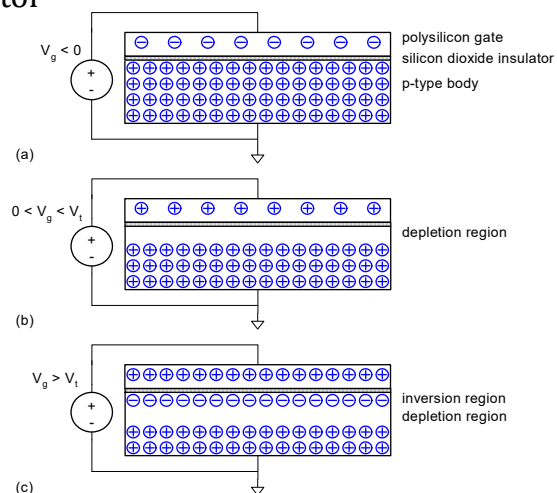
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MOS CAPACITOR



- Gate and body form MOS capacitor
- Operating modes
 - Accumulation
 - Depletion
 - Inversion



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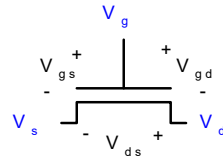
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TERMINAL VOLTAGES



- Mode of operation depends on V_g , V_d , V_s
 - $V_{gs} = V_g - V_s$
 - $V_{gd} = V_g - V_d$
 - $V_{ds} = V_d - V_s = V_{gs} - V_{gd}$
- Source and drain are symmetric diffusion terminals
 - By convention, source is terminal at lower voltage, Hence $V_{ds} \geq 0$
- nMOS body is grounded. First assume source is 0 too.
- Three regions of operation
 - Cutoff
 - Linear
 - Saturation



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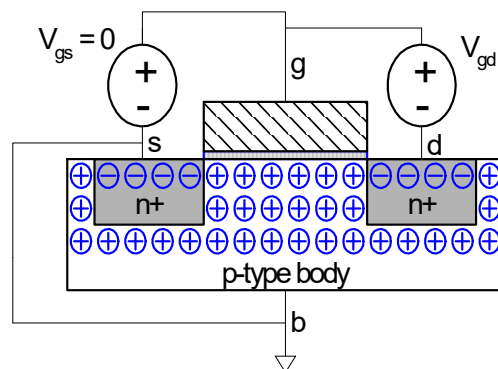
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NMOS CUTOFF



- No channel
- $I_{ds} = 0$



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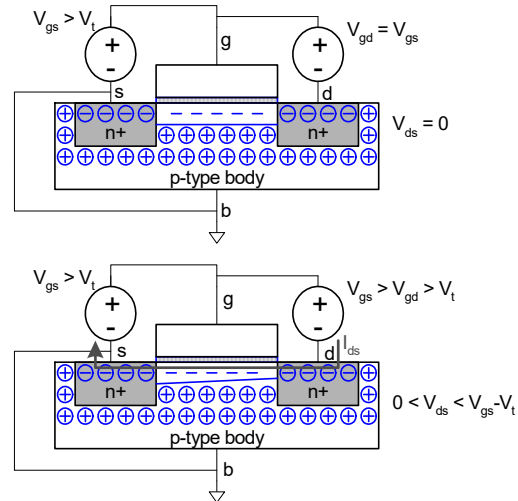
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NMOS LINEAR



- Channel forms
- Current flows from d to s
–e⁻ from s to d
- I_{ds} increases with V_{ds}
- Similar to linear resistor



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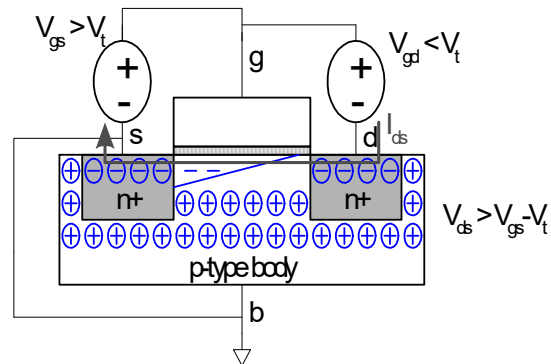
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NMOS SATURATION



- Channel pinches off
- I_{ds} independent of V_{ds}
- We say current saturates
- Similar to current source



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I-V CHARACTERISTICS



What is I & V?????

In Linear region, I_{ds} depends on
How much charge is in the channel?
How fast is the charge moving?

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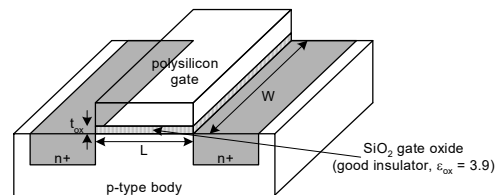
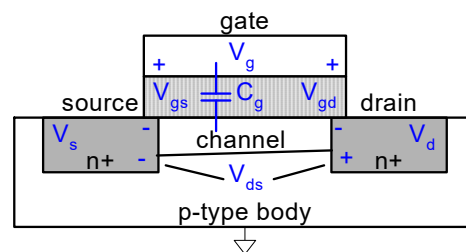
CHANNEL CHARGE



- MOS structure looks like parallel plate capacitor while operating in inversion

– Gate – oxide – channel

- $Q_{\text{channel}} = CV$
- $C = C_g = e_{\text{ox}} WL/t_{\text{ox}} = C_{\text{ox}} WL$
- $V = V_{gc} - V_t = (V_{gs} - V_{ds}/2) - V_t$



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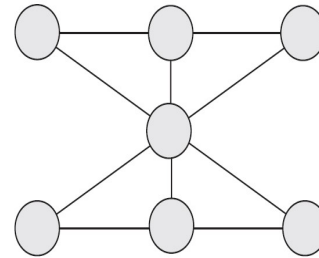


CARRIER VELOCITY & ACTIVITY



- Charge is carried by e-
- Carrier velocity v proportional to lateral E-field between source and drain
- $v = \mu E$ μ called mobility
- $E = V_{ds}/L$
- Time for carrier to cross channel:
 $-t = L / v$

•Can you put the numbers 1 to 7 In the circles so that every line adds up to 12? You can use each number only once.



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NMOS LINEAR I-V



- Now we know
 - How much charge Q_{channel} is in the channel
 - How much time t each carrier takes to cross

$$\begin{aligned}
 I_{ds} &= \frac{Q_{\text{channel}}}{t} \\
 &= \mu C_{\text{ox}} \frac{W}{L} \left(V_{gs} - V_t - \frac{V_{ds}}{2} \right) V_{ds} \\
 &= \beta \left(V_{gs} - V_t - \frac{V_{ds}}{2} \right) V_{ds}
 \end{aligned}$$

$$\beta = \mu C_{\text{ox}} \frac{W}{L}$$

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NMOS SATURATION I-V

- If $V_{gd} < V_t$ channel pinches off near drain
 - When $V_{ds} > V_{dsat} = V_{gs} - V_t$
- Now drain voltage no longer increases current

PMOS I-V



- All dopings and voltages are inverted for pMOS
- Mobility m_p is determined by holes
 - Typically 2-3x lower than that of electrons m_n
 - 120 cm²/V*s in AMI 0.6 mm process
- Thus pMOS must be wider to provide same current
 - In this class, assume $m_n / m_p = 2$

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NMOS I-V SUMMARY



- Shockley 1st order transistor models

$$I_{ds} = \begin{cases} 0 & V_{gs} < V_t & \text{cutoff} \\ \beta \left(V_{gs} - V_t - \frac{V_{ds}}{2} \right) V_{ds} & V_{ds} < V_{dsat} & \text{linear} \\ \frac{\beta}{2} (V_{gs} - V_t)^2 & V_{ds} > V_{dsat} & \text{saturation} \end{cases}$$

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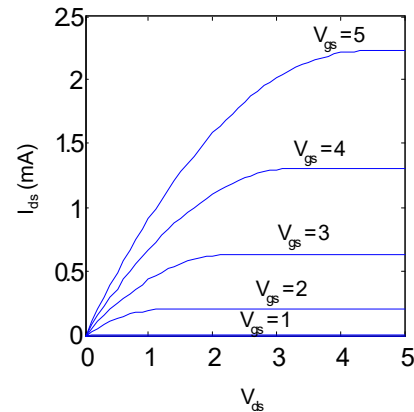
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EXAMPLE



- We will be using a 0.6 μm process for your project
 - From AMI Semiconductor
 - $t_{\text{ox}} = 100 \text{ \AA}$
 - $m = 350 \text{ cm}^2/\text{V}^2\text{s}$
 - $V_t = 0.7 \text{ V}$
- Plot I_{ds} vs. V_{ds}
 - $V_{\text{gs}} = 0, 1, 2, 3, 4, 5$
 - Use $W/L = 4/2 \mu\text{m}$



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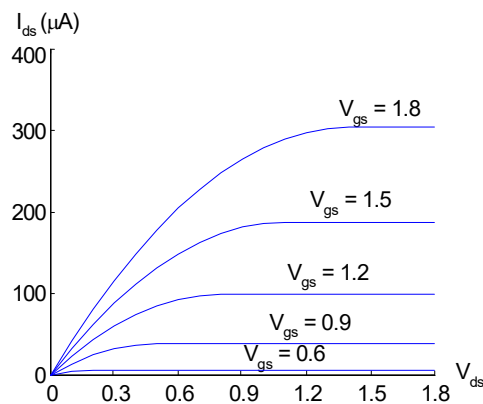
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IDEAL NMOS I-V PLOT



- 180 nm TSMC process
- Ideal Models
 - $b = 155(W/L) \text{ mA}/\text{V}^2$
 - $V_t = 0.4 \text{ V}$
 - $V_{\text{DD}} = 1.8 \text{ V}$



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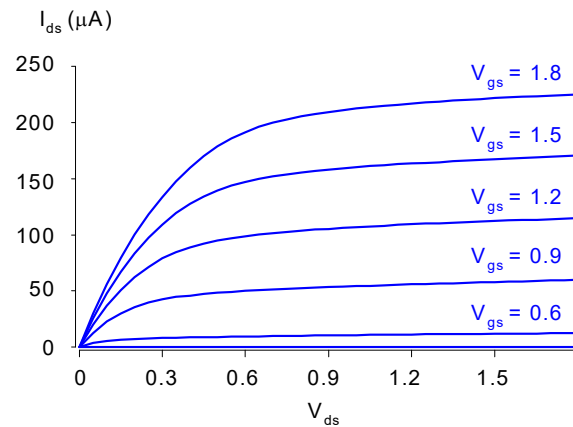
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SIMULATED NMOS I-V PLOT



- 180 nm TSMC process
- BSIM 3v3 SPICE models
- What differs?
 - Less ON current
 - No square law
 - Current increases
 - in saturation



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ASSESSMENT



1. Compare Accumulation, Depletion, Inversion modes
2. Write the I_{ds} equations for three modes in Shockley 1st order transistor models
3. Draw pMOS I-V plot

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SUMMARY & THANK YOU

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